



Corres. a Mail

9-8-3  
**BOX AF RECEIVED**  
SEP 10 2003  
TC 1700

AF/1700

DOCKET NO.: TALW-0180  
Application No.: 09/805,841  
Office Action Dated: May 5, 2003

PATENT  
REPLY FILED UNDER EXPEDITED  
PROCEDURE PURSUANT TO  
37 CFR § 1.116

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:  
**Toshiki Inoue, et al.**

Confirmation No.: 3801

Application No.: 09/805,841

Group Art Unit: 1742

Filing Date: March 14, 2001

Examiner: Nicolas, Wesley A.

For: **Electrolytic Plating Method and Device for a Wiring Board**

EXPRESS MAIL LABEL NO: EV 058068275 US  
DATE OF DEPOSIT: September 5, 2003

2/10  
NE  
P6  
09/11/03

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

REPLY PURSUANT TO 37 CFR § 1.116

In response to the Official Action dated May 5, 2003, reconsideration is respectfully requested in view of the amendments and/or remarks as indicated below:

- ☒ **Amendments to the Specification** begin on page 2 of this paper.
- ☒ **Amendments to the Claims** are reflected in the listing of the claims which begins on page 3 of this paper.
- ☐ **Amendments to the Drawings** begin on page of this paper and include an attached replacement sheet.
- ☒ **Remarks/Arguments** begin on page 7 of this paper.